

**承 認 書**  
SPECIFICATION FOR APPROVAL

客户名称: 深圳市立创电子商务有限公司  
Customer:

产品型号: M/C 156K/350VAC P37.5mm  
Product Type:

产品编码: C2913436  
Product Code:

客户料号: HAPK3A5A15K0Q030  
Customer Code:

日期: 2021年11月20日

Approval signature:

AUTHORIZED BY	CHECK BY	VALIDATED BY

承认后请寄回一份 (Please return one copy after approved)

**东莞市弘源电子有限公司**

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确 认		制 作	刘静
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### Datasheet Version update list 规格书版本更新履历

Version 版本号	Update content 变更内容	Update Date 变更日期	Remark 备注
V1.0	脚长 20mm 修改为 L0	20180926	



### HAPK 系列承认书

NO	客户料号	规格	料号
1		HAPK156K350V S=37.5mm W*H*T=42.5*45*30mm	HAPK3A5A15K0Q030
2		以下空白	
3			
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21			



PRODUCT SPECIFICATIONS  
产品规格

ISSUED DATE: 2021-11-24  
签发日期: 2021-11-24

DESCRIPTIONS :Metallized POLYPROPYLENE Film CAPACITOR

描述: 金属化聚丙烯薄膜电容器

TYPE: HMPB SERIES

系列: HAPK系列

Operating temperature :-40°C~105°C(Derate DC voltage 1.5%/ above 85°C to 105°C)

操作温度范围: -40°C~105°C (+85°C ~ +105°C, 直流电压降额系数1.5%/°C)

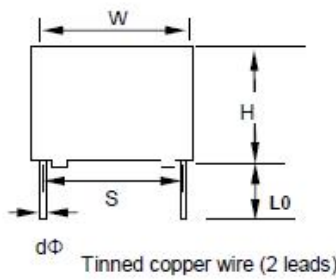


Fig. 1

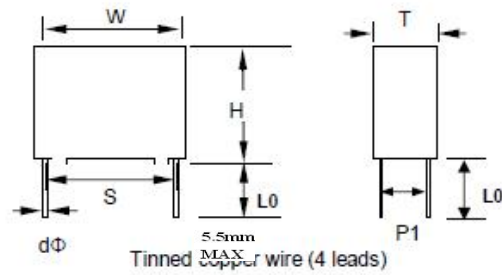


Fig. 2

PRODUCT DIMENSIONS :  
产品尺寸(mm)

CUSTOMER'S PART NO. 客户料号	CAP 容量 (uF)	To l. 误差 ± %	R.V. 电压 VAC	T.V. 耐压 VDC	W 长度 ±0.5	H 高度 ±0.5	T 厚度 ±0.5	S 脚距 +1/-0.5	P1 脚距 ±0.5	d 线径 ±0.05	L0 ±1	Fig.	HONGFARAD Cap PART NO. 我司料号	dv/dt (v/us)
	15.0	10	350	753	42.5	45.0	30.0	37.5		1.2	30	1	HAPK3A5A15K0Q080	70
Rated RMS Voltage(U <sub>rms</sub> )	Rated AC Voltage(U <sub>n</sub> )	Maximum continuous DC voltage	Ls(nH)	ESR@10 KHz(mΩ)	I(A)	Is(A)	Imax @70°C,10KHZ(A)							
350VAC	480VAC	600VDC	30	2.1	1050	3150	14							
APPROVED BY 批准:	CHECKED BY: 审核:							PREPARED BY: 制作:						
								刘静						



# HAPK SERIES CAPACITORS

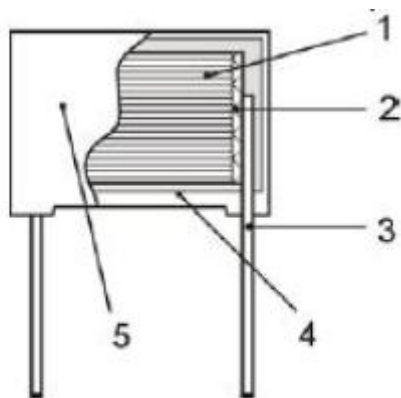
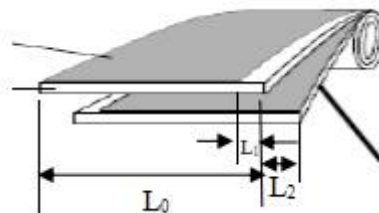
## 金属化聚丙烯薄膜电容器HAPK系列

### 1. 结构及材料(Construction and Component)

#### a 产品结构图&印字(Construction&Mark)

金属化蒸镀层/Metallized layer

聚丙烯薄膜层/POLYPROPYLENE film



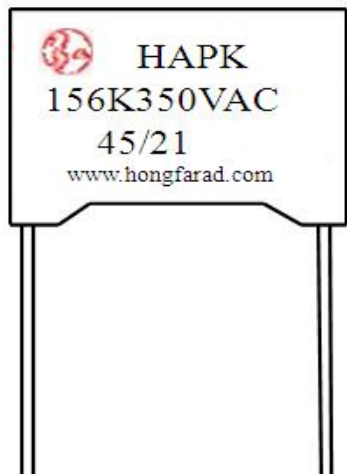
项次 Item	构成部位 Component
L <sub>0</sub>	膜宽 Width
L <sub>1</sub>	留边 Margin
L <sub>2</sub>	错边 Stagger joint
d	膜厚 Film thickness


#### B材料构成清单:(Component List)

项次 Item	构成部位 Component	材料名称/材质 Material	环保要求 RoHS Requirements
1	Element 素子	金属化聚丙烯薄膜 Metallized OPP film	符合RoHS要求 Compliant with RoHS
2	喷金层 Metal spray layer	锌线锡锌合金线 Zn and Zn-Tin alloy wire	符合RoHS要求 Compliant with RoHS
3	引线 Leads	镀锡铜包钢线 Tinned copper-base alloy wire	符合RoHS要求 Compliant with RoHS
4	灌封胶 Potting Compound	UL94V-0 级阻燃环氧树脂 Flameretardant epoxy resin(UL94V0)	符合RoHS要求 Compliant with RoHS
5	塑胶外壳 Enclosure	UL94V-0级阻燃PBT材质 Flameretardant PBT Plastic(UL 94V0)	符合RoHS要求 Compliant with RoHS
6	本体印字 Marking	激光刻印Laset	符合RoHS要求 Compliant with RoHS



Marking:



	HONGFARAD CO.LOGO
HAPK	Metallized POLYPROPYLENE Film CAPACITOR
15.0uF	CAPACITANCE
K	CAPACITANCE TOLERANCE
45/21	21years in week45
www.hongfarad.com	Website



## 2.技术规范/Technical specification

项次 NO.	检测项目 Test item	性能 Performance	检测方法(参照IEC61071;GB/T17702) Test method (refer to IEC61071;GB/T17702)
1	耐压测试 Withstand Voltage		参照4.2.1节 Ref 4.2.1 clause
	引线间(T-T)	应无永久性击穿及飞弧 No permanent breakdown or flashover	Apply 2.15% of rated voltage / 60sec
	引线与外壳间 Terminal-Case		3000Vac(60s). C ≤ 1uf 漏电流 ≤ 5.0mA C > 1 uf 漏电流 ≤ 10.0mA 电压爬升时间: AC:150V/S DC:250V/S
2	绝缘电阻 Insulation Resistance	(20℃, 100V, 1min)  C <sub>R</sub> ≤ 0.33uF; IR > 100 000MΩ C <sub>R</sub> > 0.33uF; IR * C > 30 000S	充电时间60秒 charge time 60sec 充电电压100Vdc, charge voltage 100V 参照4.2.4节 Ref 4.2.4 clause
3	容量 Capacitance	J ± 5% ; K ± 10% ; M ± 20%	参照4.2.2节 :Ref 4.2.2 clause  测试条件:1V, 1KHZ ( 25℃ ± 5℃ )
4	Dissipation factor 损耗角正切	≤ 0.0015 (0.15%) at 1 KHz.	测试条件:1V, 1KHZ ( 25℃ ± 5℃ ) 参照4.2.3节 :Ref 4.2.3 clause
5	可焊性 Solderability	被测引线90%以上上锡率 At least 90% immersed lead wire should be covered new solder.	参照4.5节: Ref 4.5 clause Ta:锡槽法(方法1) Ta: Tin bath method (1) 温度:260 ± 5℃; 时间:2 ± 0.5秒 Solder temperature :260 ± 5℃ Immersion time: 2 ± 0.5 sec
6	引线强度测试 Terminal strength	引线脚无可见的破损 There shall be no visible damage	参照4.3节 :Ref 4.3 clause 拉力Ua: 0.5 < d ≤ 0.8 , 10N ± 10% 0.8 < d ≤ 1.25, 20N ± 10% 弯力Ub: 0.5 < d ≤ 0.8 , 5N ± 10% 0.8 < d ≤ 1.25, 10N ± 10% 引线在每个方向进行两次弯曲 引线为刚性, Ub试验方式不适用 Lead to rigid, Ub test method is not applicable Tense(Ua): 0.5 < d ≤ 0.8 , 10N ± 10% 0.8 < d ≤ 1.25, 20N ± 10% Bend(Ub): 0.5 < d ≤ 0.8 , 5N ± 10% 0.8 < d ≤ 1.25, 10N ± 10% Bent 2 times each Lead to rigid, Ub test method is not applicable



项次 NO.	检测项目 Test item	性能 Performance	检测方法检测方法(参照IEC61071;GB/T17702) Test method (refer to IEC61071;GB/T17702)
7	耐焊接热 Resistance to Solder heat	There should be no visible damage, $\Delta C/C < \pm 3\%$ 外观无可见的损伤,标志清晰,容量变化率 $\Delta C/C < \pm 3\%$	参照4.4节: Ref 4.4 clause Tb:锡槽法(方法1A) Tb:Tin bath method (1 A) 温度:260 $\pm$ 5 $^{\circ}$ C; 时间:5-10秒 Solder temperature :260 $\pm$ 5 $^{\circ}$ C Immersion time: 5-10 sec
8	初始测量 Initial measurement	容量,损耗角正切 Capacitance, Tan $\delta$	
	温度快速变化 Rapid change of temperature	外观无可见的损伤 There should be no visible damage.	参照4.4节: Ref 4.4 clause $\theta A = -40^{\circ}$ C, $\theta B = +85^{\circ}$ C 循环周期:5次, 5 cycles 周期时间:30分钟 Duration=30min
	振动 Vibration	外观无可见的损伤 There should be no visible damage.	参照4.7节: Ref 4.7 clause 位移0.75mm或加速度0.98m/s <sup>2</sup> Amplitude 0.75mm or acceleration 0.98m/s <sup>2</sup> (两者取较小者) (whichever is the smaller values) 振动频率:10~500HZ, 三个方向,每2小时/方向,共6小时 2h each direction, total 6h
	Bump 碰撞	外观无可见的损伤,标志清晰,容量变化率 $\Delta C/C < \pm 5\%$ There should be no visible damage, $\Delta C/C < \pm 5\%$	参照4.8节: Ref 4.8 clause 4000次,加速度390m/s <sup>2</sup> 4000 times ,acceleration 390m/s <sup>2</sup> 脉冲持续时间:6ms. Pulse duration 6ms.
	最终测量 Final measurement	外观无可见的损伤,标志清晰,容量变化率 $\Delta C/C < \pm 5\%$ There should be no visible damage, $\Delta C/C < \pm 5\%$  损耗角正切增加:Increase of Tan $\delta$  CR $\leq$ 1uf: $\leq$ 0.003 绝缘电阻(IR):>50%的额定值 IR>50% *Rate value	





项次 NO.	检测项目 Test item	性能 Performance	检测方法(参照 IEC61071;GB/T17702) Test method (refer to IEC61071;GB/T17702)
9	气候顺序 Initial measurement 初始测量 干热 Dry heat 寒冷 Cold 循环湿热 Damp heat, cyclic		参照 4.10 节: Ref 4.10 clause
			+105℃,16h
			-40℃,2h
			试验 Db,其余循环 Test Db, remaining cycles
	最终测量及要求 Final measurement	应无可见损坏,标志清晰 There should be no visible damage, legible marking.  容量变化率 $\Delta C/C < \pm 5\%$ Capacitance change $\Delta C/C < \pm 5\%$  损耗角正切增加: Increase of $\tan \delta$ $CR \leq 1\mu f \leq 0.003$  绝缘电阻(IR):>50%的额定值 IR>50% *Rate value	
10	稳态湿热 Damp heat steady state	应无可见损坏,标志清晰 There should be no visible damage, legible marking. Capacitance change $\Delta C/C < \pm 5\%$ 容量变化率 $\Delta C/C < \pm 5\%$ 损耗角正切增加: Increase of $\tan \delta$ $C \leq 1\mu f \leq 0.005$	参照 4.11 节: Ref 4.11 clause Temperature: $40 \pm 2\%$ 温度: $40 \pm 2\%$  湿度: $93(+2/-3)\%RH$ Humidity: $93(+2/-3)\%RH$  持续时间:21天 Duration:21 days
11	耐久性 Endurance	应无可见损坏,标志清晰 There should be no visible damage, legible marking.  容量变化率 $\Delta C/C < \pm 5\%$ Capacitance change $\Delta C/C < \pm 5\%$  损耗角正切增加: Increase of $\tan \delta$ $CR \leq 1\mu f \leq 0.003$  绝缘电阻(IR):>50%的额定值 IR>50% *Rate value	参照 4.12 节: Ref 4.12 clause 在最高允许温度下 85℃, 施加 试验电压 $1.25*U$ , 试验周期 1000 小时 ( $1.25*U$ ) at 85℃,1000h



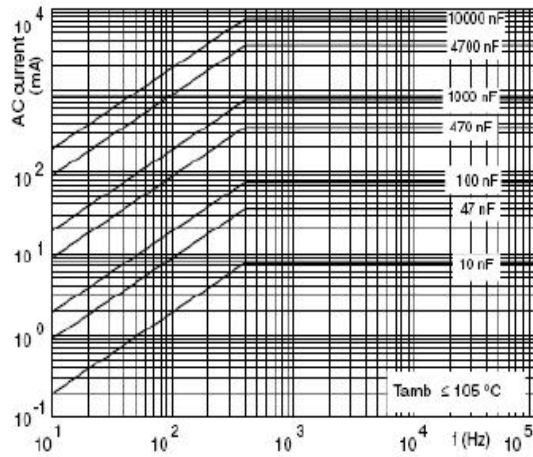
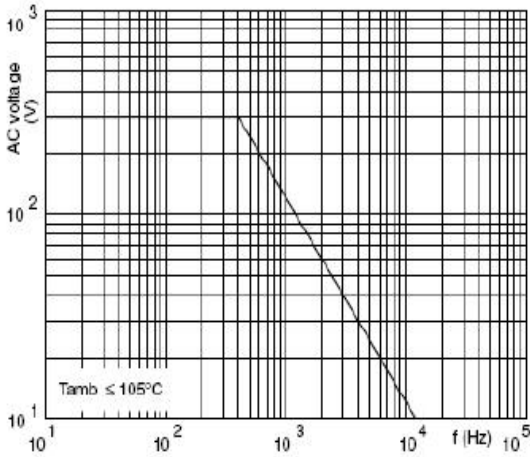
项次 NO.	检测项目 Test item	性能 Performance	检测方法(参照IEC61071;GB/T17702) Test method (refer to IEC61071;GB/T17702)
12	充放电 Charge and Discharge	应无可见损坏,标志清晰 There should be no visible damage, legible marking.  容量变化率 $\Delta C/C < \pm 5\%$ Capacitance change $\Delta C/C < \pm 5\%$  损耗角正切增加: Increase of Tan $\delta$ $CR \leq 1\mu f \leq 0.003$  绝缘电阻(IR):>50%的额定值 $R > 50\% \text{ *Rate value}$	参照4.13节: Ref 4.13 clause  试验电容 $\leq 1\mu f$ 试验次数:10000次  试验时间:0.5秒 放电电阻: $R1 = \frac{U_R}{C_R \frac{du}{dt}}$ $C > 1 \mu F$ 频率: 1KHz  $C \leq 1 \mu F$ 频率: 10KHz $C \leq 1\mu f$ Test of time:0.5s, 10000 times Discharge resistance: $R1 = \frac{U_R}{C_R \frac{du}{dt}}$
13	内部温度上升 Internal temperature rise	Temperature rise( $\Delta T$ ) $\leq 10^\circ C$  温度上升 $\leq 10^\circ C$	试验温度:正常室温. 试验应由焊接电容器印刷的另一侧电路板等的影响周围的热组件  Test temperature: normal room temperature.



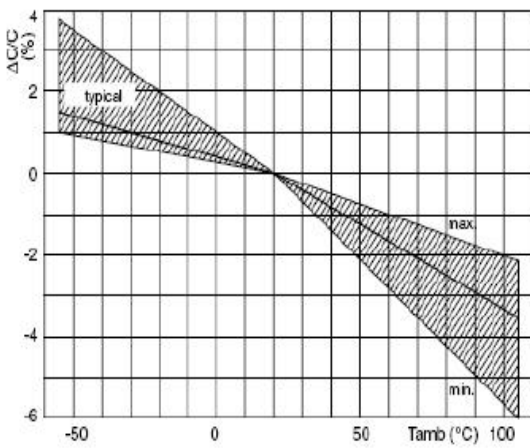
金属化聚丙烯薄膜电容器HAPK系列

3.特性曲线图 CHARACTERISTIC CURVE

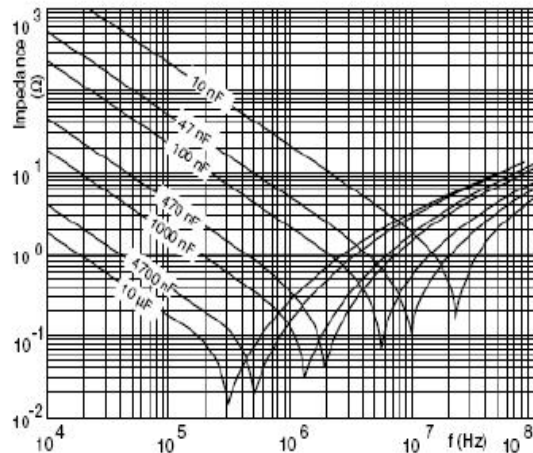
最大有效值，额定交流电压及电流对比工作频率曲线图  
MAXIMUM RMS VOLTAGE AND AC CURRENT (SINEWAVE) AS A FUNCTION OF FREQUENCY



容量变化率对比工作温度曲线图  
CAPACITANCE



电容阻抗对比工作频率曲线图  
IMPEDANCE

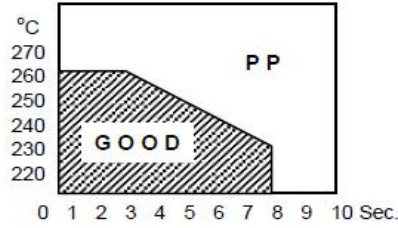
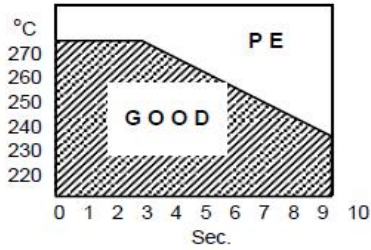




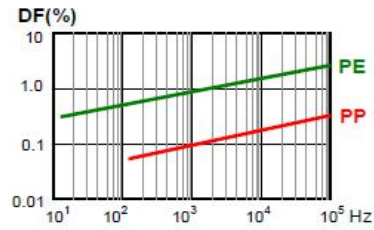
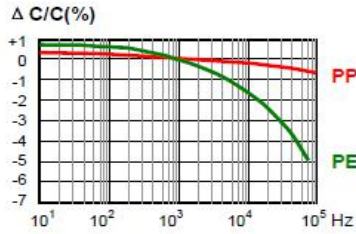
金属化聚丙烯薄膜电容器HAPK系列

CHARACTERISTICS REFERENCE

Solderring Temperature VS Time 焊接温度 VS 时间



Frequency Characteristics 频率特性



Temperature Characteristics 温度特性

